

Ceramic Disk Capacitors

Features

High reliability

Excellent solderability

Ideal for industrial and commercial applications

Part Number Description (example)

RND 150 [C] [NPO] [010] [C] [2H] [05] [D] [S1] [25]

Series [1] [2] [3] [4] [5] [6] [7] [8] [9]

[1] Type

Symbol	Type
C	Resin Coated
D	Epoxy Coated

[2] Temperature Characteristic

Temp. Charact.	Temperature Range	Capacitance Change
NPO	-25 ~ 85°C	0±60 ppm/°C
SL	-25 ~ 85°C	350 ~ -1000 ppm/°C
Y5P	-25 ~ 85°C	± 10 %
Z5U	+10 ~ 85°C	+22 %, -56 %
Z5V	+10 ~ 85°C	+22 %, -82 %

[3] Capacitance Value

Symbol	Capacitance Value
060	6pF
6R8	6.8pF
120	12pF
471	470pF
222	2200pF
104	100000pF

[4] Capacitance Tolerance

Symbol	Capacitance Tolerance
C	±0.25pF
J	±5 %
K	±10 %
M	±20 %
Z	+80 %, -20 %

[5] Rated Voltage

Symbol	Rated Voltage
2A	DC 100V
2H	DC 500V
3K	DC 3000V

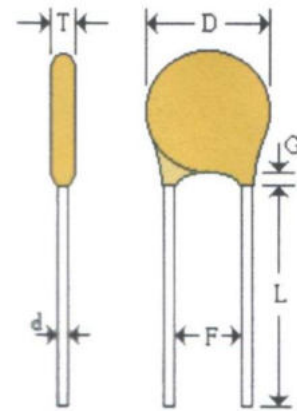
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[6] External Dimensions (D) (mm)

Symbol	05	07	10	12
Φ	5 Φ	7 Φ	10 Φ	12 Φ

[7] Lead Spacing (F) (mm)

Symbol	A	D	E	F	G
Spacing	2.5	5	6.35	7.52	10
Tol.	± 0.8				



[8] Lead Style

Symbol	S1 style	S2 style
d	0.55 $\pm$ 0.05	0.45 $\pm$ 0.05
F	Lead Spacing $\rightarrow$ Refer 1.0	
L	Lead Length $\rightarrow$ Refer 1.0	
D	Refer to Capacitance Range Chart	
T		
G		

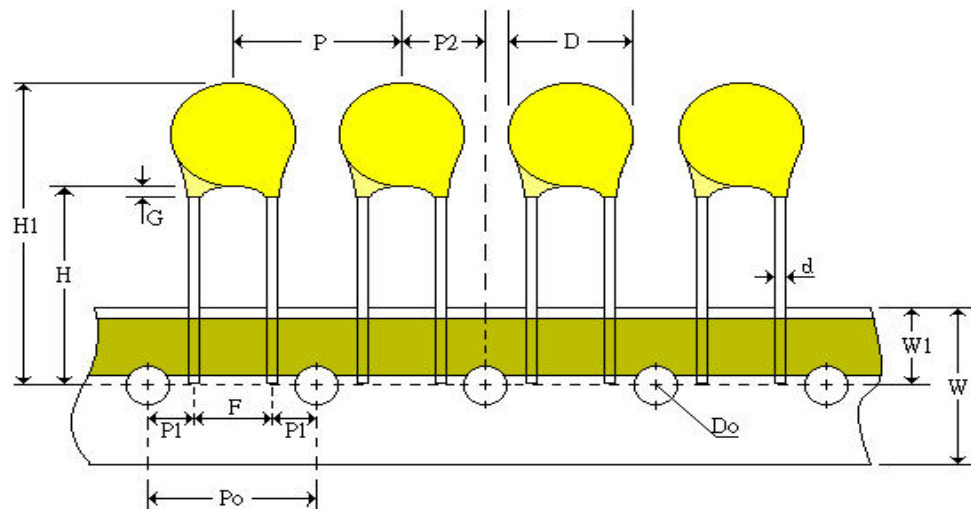
Unit:mm

S1 & S2 style

[9] Lead Length (L) (mm)

Packing	Bulk				Taping(H)	
Symbol	04	06	10	25	16	20
Length	3.5	6	10	25	16	20
Tol.	± 0.5	± 1	± 1	± 3	+1.5 -1	+1.5 -1

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Description	Symbol	(mm)	REMARK
Carrier Tape Width	W	18±0.5	
Position of Sprocket Hole	W1	9±0.5	
Pitch of Component	P	12.7 Ref.	
Pitch of Sprocket hole	P0	12.7±0.3	
Length from Hole Center to Lead	P1	5.1±0.7	P1=3.18± 0.7 refer to F=6.35±0.8
		3.85±0.7	
		3.18±0.7	
Length from Hole Center to Component Center	P2	6.35 Ref.	
Diameter of Sprocket Hole	Do	4±0.3	
Diameter of Body	D		Refer Capacitance Range Chart
Diameter of Lead Wire	d	0.55±0.05	
Lead Spacing	F	2.5±0.8	
		5±0.8	
		6.35±0.8	
Lead Crimped Height	H	16	Tolerance +1.5 -1
		20	
Top of Component Height	H1	32.25max.	
Coating extension on Lead	G		Refer Capacitance Range Chart
Thickness of Body	T		Refer Capacitance Range Chart

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3.0 Capacitance Range Chart (Class I , II)

(Max. Capacitance in pF)

W.Vdc	NPO (CH)	SL	B (Y5P)	E (Z5U)	F (Z5V)	Dimensions (mm)		
						D	T	G
50V 100V	0.5~22	15~180	100~2200	1000~5000	3300~10000	5±1	<3.5	<1.5
	51~68	200~270	3300~4700	5600~10000	12000~22000	6±1	<3.5	<1.5
	100~120	300~390	3900~5600			7±1	<3.5	<1.5
		390~470	6800			8±1	<3.5	<1.5
		560~680				9±1	<3.5	<1.5
			8200~10000			10±1	<3.5	<1.5
						12±1	<3.5	<1.5

(Max. Capacitance in pF)

W.Vdc	SL	B (Y5P)	E (Z5U)	F (Z5V)	Dimensions (mm)		
					D	T	G
500V 630V	15~100	100~1000	1000~1200		5±1	<3.8	<2.0
	82~120	1200~1500	1500~2200	3300~5000	6±1	<3.8	<2.0
	150~220	1800~2200	2700~4700	5600~6800	7±1	<3.8	<2.0
	270~330	2700~3000	5600~6800	8200~10000	8±1	<3.8	<2.0
	390~470	3300~3900	8200~10000		9±1	<3.8	<2.0
		4700~5000			10±1	<3.8	<2.0
		5600~6800	12000~15000	15000~22000	12±1	<3.8	<2.0
		10000	18000~22000	27000~47000	14±1	<3.8	<2.0
				100000	16±1	<3.8	<2.0

3.0 Semi-Conductive Capacitance Range Chart (Class III)

(Max. Capacitance in pF)

W.Vdc	B (Y5P)	Dimensions (mm)		
		D	T	G
16V		6±1	<3	<1.5
		9±1	<3	<1.5
25V		4.5±1	<3	<1.5
		5±1	<3	<1.5
		6±1	<3	<1.5
50V		4±1	<3	<1.5
	3900~10000	5±1	<3	<1.5
	22000	6±1	<3	<1.5
		7±1	<3	<1.5
	47000~50000	8±1	<3	<1.5
		9±1	<3	<1.5

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4.0 Medium-High Voltage Capacitance Range Chart (Class I 、 II)

(Max. Capacitance in pF)

W.Vdc	SL	B (Y5P)	E (Z5U)	F (Z5V)	Dimensions (mm)		
					D	T	G
1KV	15~62	100~470	1000~1200		5±1	<3.8	<2.0
	68~100	330~1000	1500~2200		6±1	<3.8	<2.0
	120~150	1000~1500	2700~3300	4700~6800	7±1	<3.8	<2.0
	180~220	1500~1800	3900		8±1	<3.8	<2.0
	270~330	2000~2200	4700~5600	8200~10000	9±1	<3.8	<2.0
	390	2700~3300	6800,10000	12000	10±1	<3.8	<2.0
			8200~10000	15000	11±1	<3.8	<2.0
	470~560	3900~4700	10000~12000		12±1	<3.8	<2.0
		5000~6800	15000	18000~22000	14±1	<3.8	<2.0
				100000	22±1	<3.8	<2.0

W.Vdc	SL	B (Y5P)	E (Z5U)	F (Z5V)	Dimensions (mm)		
					D	T	G
2KV	15~56	100~470	1000~1200		5±1.5	<4.5	<2.0
	68~100	560~820	1500~2200	2200~3900	6±1.5	<4.5	<2.0
	120~150	1000~1200	2700~3300		7±1.5	<4.5	<2.0
	180	1500	3900	3300~6800	8±1.5	<4.5	<2.0
	200~220	1800~2000		6800~8200	9±1.5	<4.5	<2.0
	270~300	2200~2700	4700~5600	10000	10±1.5	<4.5	<2.0
	330	3000~3300			11±1.5	<4.5	<2.0
		3900	6800		12±1.5	<4.5	<2.0
	390				13±1.5	<4.5	<2.0
		4700~5600	8200~10000		14±1.5	<4.5	<2.0

W.Vdc	SL	B (Y5P)	E (Z5U)	F (Z5V)	Dimensions (mm)		
					D	T	G
3KV	15~47	100~470	1000~1200	1800~2200	7±1.5	<4.5	<3.0
	47~68	680~820	1500	2700	8±1.5	<4.5	<3.0
	82~100	1000	1800~2000	3900	9±1.5	<4.5	<3.0
	120	1200	2200~2700	3300~5600	10±1.5	<4.5	<3.0
	150	1500	3000~3300		11±1.5	<4.5	<3.0
	180~220	1800		6800~8200	12±1.5	<4.5	<3.0
	270	2000~2200	3900~4700		13±1.5	<5	<3.0
	300~330			10000	14±1.5	<5	<3.0
		2700~3300	5000~6800		15±1.5	<5	<3.0

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5.0 Specification

No	Item	Class I	Class II	Class III	Measuring Condition															
1	Visual and mechanical examination	To be within the specifications shows in			Capacitors shall be visually inspected for visible evidence of defect. Dimensions shall be measured with calipers or micrometers. Marking shall be legibility.															
2	Operating Temperature Range	– 25℃ to +85℃	Y5P : – 25℃ to +85℃ Z5U & Z5V : +10℃ to +85℃	Y5P : – 25℃ to +85℃	Class III is semi-conductor material															
3	Temperature Characteristics	NPO(CH) : 0 ± 60ppm/℃ SL : +350 to -1000ppm/℃	Y5P : ± 10% Z5U : +22% –56% Z5V : +22% –82%	Y5P : ±10 %	Retain the sample for 30 minutes at the temperature specified below in the sequence listed in the table. Then measure the capacitance in each step after thermal equilibrium at each temperature is reached <table><tr><td>Step 1</td><td>Step 2</td><td>Step 3</td><td>Step 4</td><td>Step 5</td></tr><tr><td>Room Temp.</td><td>Min. Operating Temp.</td><td>Room Temp.</td><td>Max. Operating Temp.</td><td>Room Temp.</td></tr><tr><td>25±2℃</td><td>-25±3℃ 10±2℃</td><td>25±2℃</td><td>85±2℃</td><td>25±2℃</td></tr></table> Note that step 1 and 2 do not apply for the SL characteristics.	Step 1	Step 2	Step 3	Step 4	Step 5	Room Temp.	Min. Operating Temp.	Room Temp.	Max. Operating Temp.	Room Temp.	25±2℃	-25±3℃ 10±2℃	25±2℃	85±2℃	25±2℃
Step 1	Step 2	Step 3	Step 4	Step 5																
Room Temp.	Min. Operating Temp.	Room Temp.	Max. Operating Temp.	Room Temp.																
25±2℃	-25±3℃ 10±2℃	25±2℃	85±2℃	25±2℃																
4	Capacitance	To be within the specified tolerance			Shall be measured at 25℃± 2℃ normal temperature at the frequency and voltage															
5	Q or Dissipation Factor (tanδ)	C≥30pF : Q≥1000 C<30pF : Q≥400 + 20 × C (C is nominal capacitance)	Y5P & Z5U : tanδ ≤0.025 Z5V : tanδ ≤0.05	Y5P : tanδ ≤0.05	Class I : 1MHz ±20 ,% 1± 0.2Vrms Class II : 1KHz ±10% , 1± 0.2Vrms Class III : 1KHz ±10 ,% 0.5± 0.05Vrms															
6	Withstanding Voltage	No defects			Applied voltage : Rated voltage ×3 (Class I) Rated voltage ×2.5 (Class II) Rated voltage ×2 (Class III) Duration : 1 to 5 sec. The charge/discharge current is less than 50mA															
7	Insulation Resistance	More than 10GΩ	More than 10GΩ or 200M Ω • F ₁ whichever is less.	More than 1GΩ or 20M Ω • F ₁ whichever is less.	Apply rated voltage for 1 minute at 25℃± 2℃ and 70% R.H. max. 16Vdc product : Measurement voltage is 25Vdc															
8	Strength of Lead	Termination not to be broken or loosened			Fix the capacitor, apply the tensile stress listed below in the terminal extraction direction until the designated value is reached, then retain the capacitor for 10 ± 1 seconds as is. <table><tr><td>Nominal wire diameter</td><td>0.5mm</td><td>0.6mm</td></tr><tr><td>Tensile stress</td><td>1kg</td><td>1.5kg</td></tr></table>	Nominal wire diameter	0.5mm	0.6mm	Tensile stress	1kg	1.5kg									
Nominal wire diameter	0.5mm	0.6mm																		
Tensile stress	1kg	1.5kg																		
9	Solderability of leads	At least 75% of the immersed surface in the circumference direction is covered with new solder.			Solder temperature : Class I : 260 ± 5℃ Class II, III : 250 ± 5℃ Dipping : 2 ± 0.5 sec. (Flux shall be used)															

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5.0 Specification

No	Item		Class I	Class II	Class III	Measuring Condition															
10	Resistance to Soldering heat	ΔC	± 2.5% or ± 0.25pF (Whichever is greater)	Y5P : ± 5% Z5U : ± 15% Z5V : ± 20%	Y5P : ± 7.5%	The lead wire is immersed in the melted solder 1.5mm to 2mm from the capacitor body (Class I, II) Solder temperature : 350 ± 10℃ Duration : 3 ± 0.5sec. (Class III) Solder temperature : 260 ± 5℃ Duration : 5 ± 0.5sec. The measurements after testing must be taken after leaving the sample for 12 to 24 hours under normal temperature and humidity conditions.															
		Withstanding voltage	No defects																		
		Exterior	No abnormalities																		
11	Temperature and Immersion cycling	ΔC	± 5% or ± 0.5pF (Whichever is greater)	Y5P : ± 10% Z5U : ± 20% Z5V : ± 30%	Y5P : ± 15 %	<table><tr><td>Step</td><td>1</td><td>2</td><td>3</td><td>4</td></tr><tr><td>Temp. (℃)</td><td>Min. Operating Temp.</td><td>Room Temp.</td><td>Max. Operating Temp.</td><td>Room Temp.</td></tr><tr><td>Time (min.)</td><td>30±3</td><td>15</td><td>30±3</td><td>15</td></tr></table> The measurements after testing must be taken after leaving the sample for 12 to 24 hours under normal temperature and humidity conditions.	Step	1	2	3	4	Temp. (℃)	Min. Operating Temp.	Room Temp.	Max. Operating Temp.	Room Temp.	Time (min.)	30±3	15	30±3	15
		Step	1	2	3		4														
		Temp. (℃)	Min. Operating Temp.	Room Temp.	Max. Operating Temp.		Room Temp.														
		Time (min.)	30±3	15	30±3		15														
		Q/D.F.	C≥30pF : Q≥350 10pF>C<30pF : Q≥275 + $\frac{5}{2}$ × C C≤10pF : Q≥200 + 10 × C (C is nominal capacitance)	Y5P & Z5U : tanδ ≤0.05 Z5V : tanδ ≤0.075	Y5P : tanδ ≤0.05																
		I.R.	More than 1GΩ	More than 1GΩ or 20M Ω • F,whichever is less.	More than 500MΩ or 10M Ω • F,whichever is less.																
Withstanding voltage	No defects																				
Exterior	No abnormalities																				
12	Humidity Loading	ΔC	± 7.5% or ± 0.75pF (Whichever is greater)	Y5P : ± 10% Z5U : ± 20% Z5V : ± 30%	Y5P : ± 15 %	Temperature : 40 ± 2℃ Humidity : 90 to 95% R.H. Duration : 500 ⁺²⁴ ₋₀ hrs. The rated voltage continuously applied. The charge/discharge current is less than 10mA. The measurements after testing must be taken after leaving the sample for 1 to 2 hours under normal temperature and humidity conditions. • Perform a heat treatment at 40 ± 2℃ for 1 hour. Remove and let sit for 1 to 2 hours at normal temperature and humidity conditions. Perform the initial measurement.															
		Q/D.F.	C≥30pF : Q≥200 C<30pF : Q≥100 + $\frac{10}{3}$ × C (C is nominal capacitance)	Y5P & Z5U : tanδ ≤0.05 Z5V : tanδ ≤0.075	Y5P : tanδ ≤0.075																
		I.R.	More than 1GΩ	More than 1GΩ or 20M Ω F,whichever is less.	More than 500MΩ or 10M Ω • F,whichever is less.																
		Withstanding voltage	No defects																		
		Exterior	No abnormalities																		

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5.0 Specification

No	Item		Class I	Class II	Class III	Measuring Condition	
13	Life	ΔC	± 5% or ± 0.5pF (Whichever is greater)	Y5P : ± 10% Z5U : ± 20% Z5V : ± 30%	Y5P : ± 15 %	Applied voltage : Rated voltage ×2(Class I, II) Rated voltage ×1.25(Class III) Temperature : 85± 2℃	
		Q / D.F.	C≥30pF : Q≥350 10pF>C<30pF : $Q \geq 275 + \frac{5}{2} \times C$ C≤10pF : Q≥200 + 10 × C (C is nominal capacitance)	Y5P & Z5U : $\tan\delta \leq 0.05$ Z5V : $\tan\delta \leq 0.075$	Y5P : $\tan\delta \leq 0.075$	Duration : 1000 ⁺⁴⁸ ₋₀ hrs. The charge/discharge current is less than 10mA. The measurements after testing must be taken after leaving the sample for 12 to 24 hours under normal temperature and humidity conditions.	
		I.R.	More than 1GΩ	More than 1GΩ or 20M Ω • F,whichever is less.	More than 500MΩ or 10M Ω • F,whichever is less.	• Perform a heat treatment at 85± 2℃ for 1 hour. Remove and let sit for 12 to 24 hours at normal temperature and humidity conditions. Perform the initial measurement.	
		Withstanding voltage	No defects				
		Exterior	No abnormalities				

* Note on standard condition : "standard condition"referred to herein is defined as follows :

5 to 35°C of temperature, 45 to 85% relative humidity, and 860 to 1060 mbar of air pressure.

When there are questions concerning measurement results :

In order to provide correlation data, the test shall be conducted under condition of $23^\circ\text{C} \pm 2^\circ\text{C}$ of temperature, 60 to 70% relative humidity, and 860 to 1060 mbar of air pressure, unless otherwise specified, all the tests are conducted under the"standard condition".

6.0 Storage

1. The storage conditions should be:

Temperature = Lower than 40°C

Humidity = Lower than 70% R.H.

2. After opening the package, please store in desiccators.